

UP Storage SuperServer SSG-522B-ACR12L

2U UP front-loading storage server with 12 direct-attached hot-swap 3.5" SAS/SATA/NVMe bays (SAS HBA) and PCIe 5.0



More details here

Key Applications

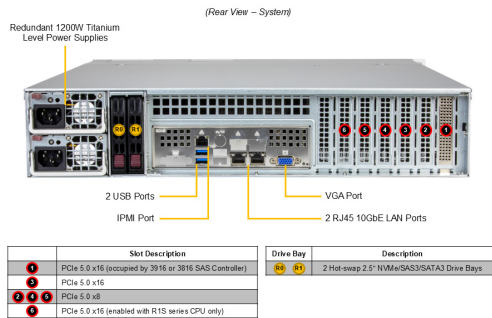
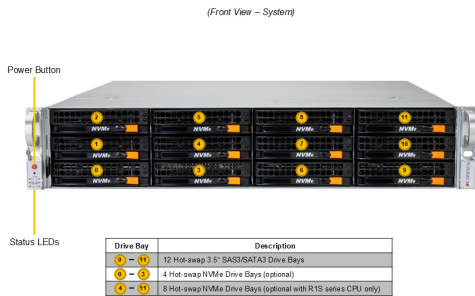
General Purpose Computing, Data Center Enterprise Applications, iSCSI SAN, Database Processing & Storage, Corporate Database, Appliance Optimized Storage Building Blocks,

Key Features

- HBA by Broadcom® SAS3816 on both front and rear drive bays;
- Single Intel® Xeon® 6700/6500 series processor up to 350W TDP;
- Up to 2TB DDR5-6400MT/s ECC Registered in 8 DIMM slots (1DPC);
- 2 onboard 10GbE ports via Intel® X550 and 1 GbE port for BMC via Aspeed AST2600;
- Six total PCIe slots: 3 PCIe 5.0 x8 + 3 PCIe 5.0 x16 slots *
* Slot 1 is occupied by system's default controller;
- 2U all hybrid hot-swap NVMe/SAS3/SATA3 front(3.5" x 12) and rear(2.5" x 2) drive bays *
* up to total 12 NVMe ports in the system;
- 1200W Redundant Titanium Level (96%) Hot-plug power supplies;



Form Factor	2U Rackmount Enclosure: 437 x 89 x 650mm (17.2" x 3.5" x 25.6") Package: 673 x 292 x 864mm (26.5" x 11.5" x 34")
Processor	Single Socket E2 (LGA-4710) Intel® Xeon® 6700/6500 series processors with P-cores or 6700 series processors with E-cores P-cores: Up to 86C/172T; Up to 336MB Cache E-cores: Up to 144C/144T; Up to 108MB Cache
System Memory	Slot Count: 8 DIMM slots/8 Channels Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 14 bays <ul style="list-style-type: none"> • 12 front hot-swap 3.5" NVMe*/SAS/SATA drive bays • 2 rear hot-swap 2.5" NVMe*/SAS/SATA drive bays (*NVMe support may require additional storage controller and/or cables) M.2: 2 M.2 PCIe 5.0 x2 NVMe slots (M-key 22110(default))
Expansion Slots	Default <ul style="list-style-type: none"> • 3 PCIe 5.0 x16 (in x16) LP slots • 3 PCIe 5.0 x8 (in x8) LP slots
On-Board Devices	SATA: 4 x SlimSAS SAS: SAS (12Gbps) via Broadcom® 3816; (IT mode) NVMe: NVMe; RAID 0/1 support(Intel® VROC RAID key required) Chipset: System on Chip Network Connectivity: 2 RJ45 10GbE with Intel® X550
Input / Output	LAN: 2 RJ45 10 GbE LAN ports (Intel® X550) 1 RJ45 1 GbE Dedicated BMC LAN port (IPMI shared on LAN port 1) USB: 2 USB 3.2 Gen1 ports(Header) 2 USB 3.2 Gen1 ports(Rear) Video: 1 VGA port(Rear) Serial: 1 COM port(header) TPM: 1 TPM header



System Cooling	Fans: Up to 3 Heavy Duty PWM 80x80x38mm Fan(s) Air Shroud: 1 Air Shroud
Power Supply	2x 1200W Redundant (1 + 1) Titanium Level (96%) Hot-plug power supplies
System BIOS	BIOS Type: AMI 64MB UEFI BIOS Features: ACPI 6.5 SMBIOS 3.7 or later UEFI 2.9
Management	SuperCloud Composer®; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory 8 Phase-switching voltage regulator FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: CPU thermal trip support, Monitoring for CPU and chassis environment, PECI
Dimensions and Weight	Weight: Gross Weight: 58 lbs (26.3 kg) Net Weight: 34 lbs (15.4 kg) Available Color: Black
Operating Environment	RoHS Compliant Operating Temperature: 10°C to 35°C (50°F to 95°F) Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X14SBI-TF
Chassis	CSE-826BTS-R1K23LPBP2